

DATA SHEET

74ALVC16245/74ALVCH16245

2.5V/3.3V 16-bit bus transceiver with
direction pin (3-State)

Product specification
Supersedes data of 1998 Jun 16
IC24 Data Handbook

1998 Jun 29

16-bit bus transceiver with direction pin (3-State)

74ALVC16245/
74ALVCH16245

FEATURES

- Wide supply voltage range of 1.2V to 3.6V
- Complies with JEDEC standard no. 8-1A
- CMOS low power consumption
- MULTIBYTE™ flow-through standard pin-out architecture
- Low inductance multiple V_{CC} and ground pins for minimum noise and ground bounce
- Direct interface with TTL levels
- All data inputs have bus hold (74ALVCH16245 only)
- Output drive capability 50Ω transmission lines @ 85°C
- Current drive ± 24 mA at 3.0 V

DESCRIPTION

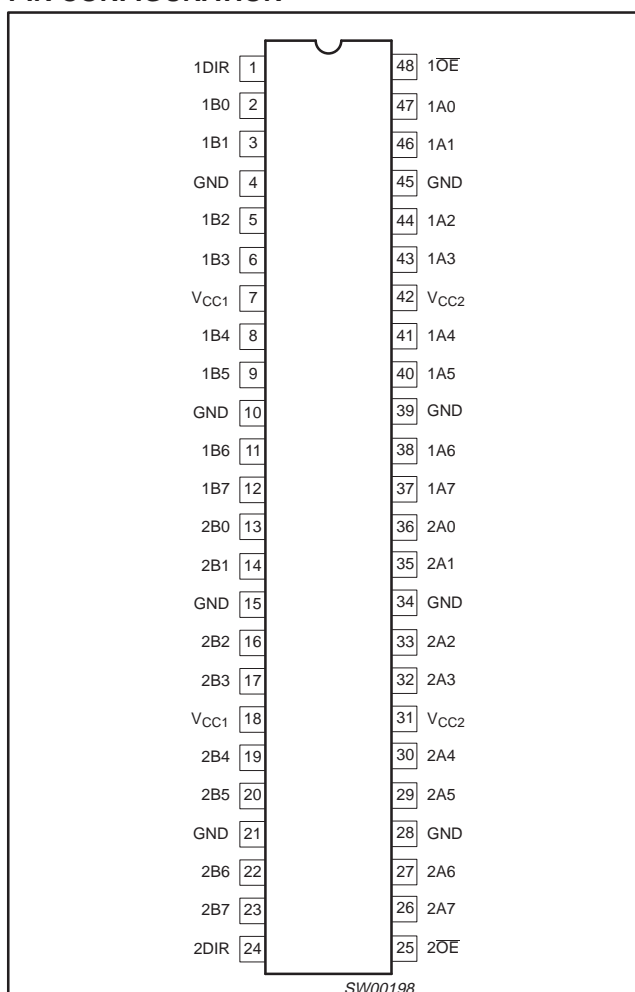
The 74ALVC16245(74ALVCH16245) is a 16-bit transceiver featuring non-inverting 3-State bus compatible outputs in both send and receive directions.

The 74ALVC16245(74ALVCH16245) features two output enable ($n\overline{OE}$) inputs for easy cascading and two send/receive ($n\overline{DIR}$) inputs for direction control. $n\overline{OE}$ controls the outputs so that the buses are effectively isolated. This device can be used as two 8-bit transceivers or one 16-bit transceiver.

The 74ALVCH16245 has active bus hold circuitry which is provided to hold unused or floating data inputs at a valid logic level. This feature eliminates the need for external pull-up or pull-down resistors.

The 74ALVC16245 has 5V tolerant inputs.

PIN CONFIGURATION



QUICK REFERENCE DATA

$GND = 0V$; $T_{amb} = 25^{\circ}C$; $t_r = t_f \leq 2.5ns$

| SYMBOL | PARAMETER | CONDITIONS | TYPICAL | UNIT | |
|-------------------|--|--|------------------|------|----|
| t_{PHL}/t_{PLH} | Propagation delay An to Bn; Bn to An | $V_{CC} = 2.5V, C_L = 30pF$ $V_{CC} = 3.3V, C_L = 50pF$ | 1.9 | ns | |
| C_I | Input capacitance | | 4.0 | pF | |
| $C_{I/O}$ | Input/output capacitance | | 8.0 | pF | |
| C_{PD} | Power dissipation capacitance per buffer | $V_I = GND$ to V_{CC}^1 | Outputs enabled | 29 | pF |
| | | | Outputs disabled | 5 | |

NOTE:

1. C_{PD} is used to determine the dynamic power dissipation (P_D in μW):
 $P_D = C_{PD} \times V_{CC}^2 \times f_i + \Sigma (C_L \times V_{CC}^2 \times f_o)$ where: f_i = input frequency in MHz; C_L = output load capacitance in pF;
 f_o = output frequency in MHz; V_{CC} = supply voltage in V; $\Sigma (C_L \times V_{CC}^2 \times f_o)$ = sum of the outputs.

ORDERING INFORMATION

| PACKAGES | TEMPERATURE RANGE | OUTSIDE NORTH AMERICA | NORTH AMERICA | DWG NUMBER |
|------------------------------|----------------------------------|-----------------------|---------------|------------|
| 48-Pin Plastic SSOP Type III | $-40^{\circ}C$ to $+85^{\circ}C$ | 74ALVC16245 DL | AC16245 DL | SOT370-1 |
| 48-Pin Plastic TSSOP Type II | $-40^{\circ}C$ to $+85^{\circ}C$ | 74ALVC16245 DGG | AC16245 DGG | SOT362-1 |
| 48-Pin Plastic SSOP Type III | $-40^{\circ}C$ to $+85^{\circ}C$ | 74ALVCH16245 DL | ACH16245 DL | SOT370-1 |
| 48-Pin Plastic TSSOP Type II | $-40^{\circ}C$ to $+85^{\circ}C$ | 74ALVCH16245 DGG | ACH16245 DGG | SOT362-1 |

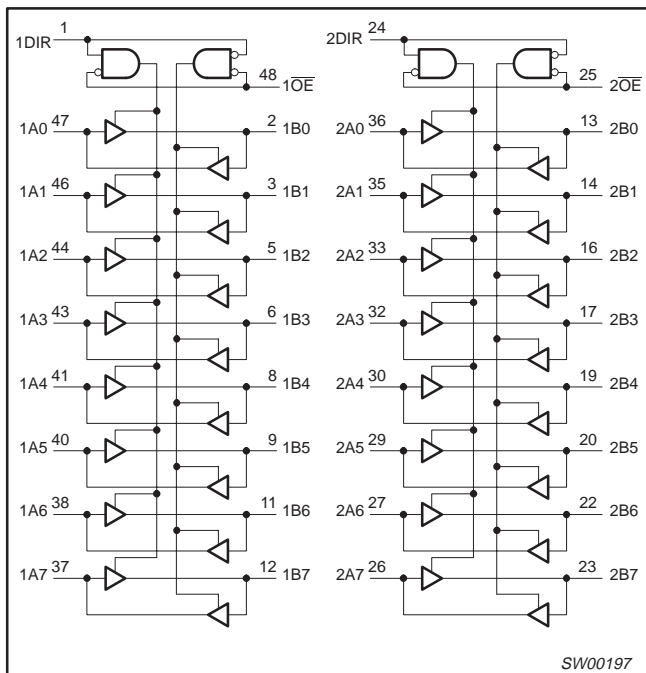
16-bit bus transceiver with direction pin (3-State)

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PIN DESCRIPTION

| PIN NUMBER | SYMBOL | NAME AND FUNCTION |
|--------------------------------|-----------------|----------------------------------|
| 1 | 1DIR | Direction control |
| 2, 3, 5, 6, 8, 9, 11, 12 | 1B0 to 1B7 | Data inputs/outputs |
| 4, 10, 15, 21, 28, 34, 39, 45 | GND | Ground (0V) |
| 7, 18, 31, 42 | V _{CC} | Positive supply voltage |
| 13, 14, 16, 17, 19, 20, 22, 23 | 2B0 to 2B7 | Data inputs/outputs |
| 24 | 2DIR | Direction control |
| 25 | 2OE | Output enable input (active LOW) |
| 36, 35, 33, 32, 30, 29, 27, 26 | 2A0 to 2A7 | Data inputs/outputs |
| 47, 46, 44, 43, 41, 40, 38, 37 | 1A0 to 1A7 | Data inputs/outputs |
| 48 | 1OE | Output enable input (active LOW) |

LOGIC SYMBOL

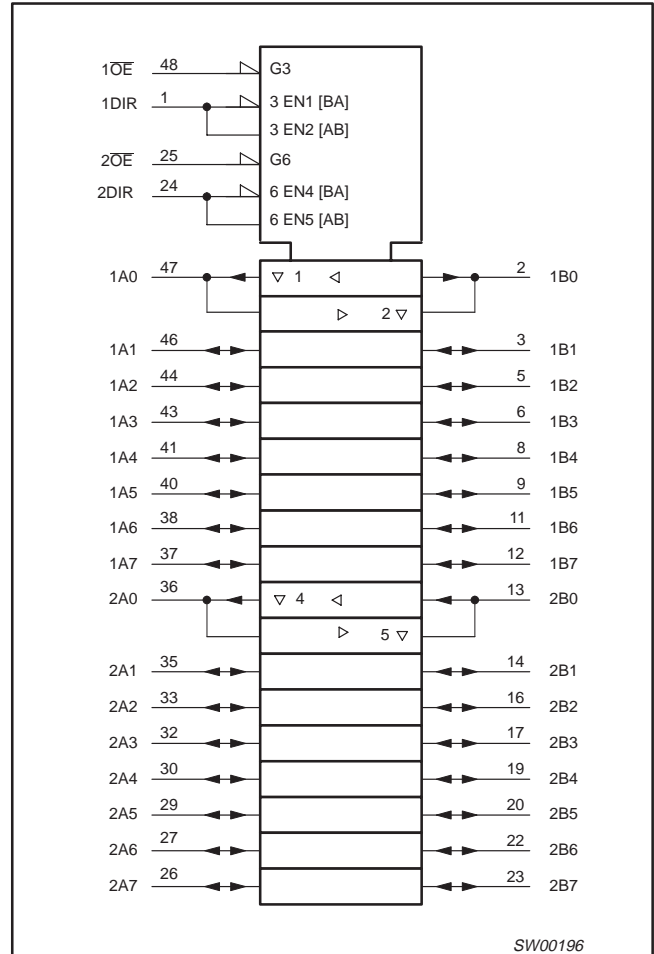


FUNCTION TABLE

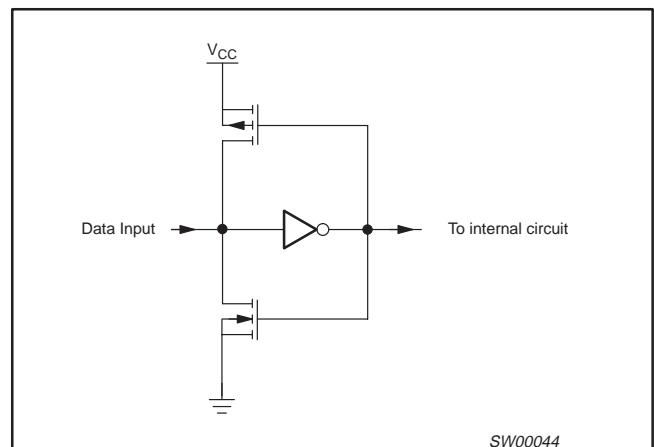
| INPUTS | | INPUTS/OUTPUT | |
|--------|------|---------------|--------|
| nOE | nDIR | nAn | nBn |
| L | L | A = B | inputs |
| L | H | inputs | B = A |
| H | X | Z | Z |

H = HIGH voltage level
L = LOW voltage level
X = don't care
Z = high impedance OFF-state

LOGIC SYMBOL (IEEE/IEC)



BUS HOLD CIRCUIT



16-bit bus transceiver with direction pin (3-State)

74ALVC16245/
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RECOMMENDED OPERATING CONDITIONS

| SYMBOL | PARAMETER | CONDITIONS | LIMITS | | UNIT |
|------------|---|--|--------|----------|------|
| | | | MIN | MAX | |
| V_{CC} | DC supply voltage 2.5V range (for max. speed performance @ 30 pF output load) | | 2.3 | 2.7 | V |
| | DC supply voltage 3.3V range (for max. speed performance @ 50 pF output load) | | 3.0 | 3.6 | |
| | DC supply voltage (for low-voltage applications) | | 1.2 | 3.6 | |
| V_I | DC Input voltage range | | 0 | V_{CC} | V |
| V_O | DC output voltage range | | 0 | V_{CC} | V |
| T_{amb} | Operating free-air temperature range | | -40 | +85 | °C |
| t_r, t_f | Input rise and fall times | $V_{CC} = 2.3 \text{ to } 3.0\text{V}$ $V_{CC} = 3.0 \text{ to } 3.6\text{V}$ | 0 0 | 20 10 | ns/V |

ABSOLUTE MAXIMUM RATINGS

In accordance with the Absolute Maximum Rating System (IEC 134)

Voltages are referenced to GND (ground = 0V)

| SYMBOL | PARAMETER | CONDITIONS | RATING | UNIT |
|-------------------|---|---|------------------------|------|
| V_{CC} | DC supply voltage | | -0.5 to +4.6 | V |
| I_{IK} | DC input diode current | $V_I < 0$ | -50 | mA |
| V_I | DC input voltage | For data inputs with bus hold ¹ | -0.5 to $V_{CC} + 0.5$ | V |
| | | For data inputs without bus hold ¹ | -0.5 to +4.6 | |
| | | For control pins ¹ | -0.5 to +4.6 | |
| I_{OK} | DC output diode current | $V_O > V_{CC}$ or $V_O < 0$ | ±50 | mA |
| V_O | DC output voltage | Note 1 | -0.5 to $V_{CC} + 0.5$ | V |
| I_O | DC output source or sink current | $V_O = 0$ to V_{CC} | ±50 | mA |
| I_{GND}, I_{CC} | DC V_{CC} or GND current | | ±100 | mA |
| T_{stg} | Storage temperature range | | -65 to +150 | °C |
| P_{TOT} | Power dissipation per package -plastic medium-shrink (SSOP) -plastic thin-medium-shrink (TSSOP) | For temperature range: -40 to +125 °C | 850 | mW |
| | | above +55°C derate linearly with 11.3 mW/K above +55°C derate linearly with 8 mW/K | 600 | |

NOTE:

1. The input and output voltage ratings may be exceeded if the input and output current ratings are observed.

16-bit bus transceiver with direction pin (3-State)

74ALVC16245/
74ALVCH16245**DC CHARACTERISTICS**

Over recommended operating conditions. Voltage are referenced to GND (ground = 0 V).

| SYMBOL | PARAMETER | TEST CONDITIONS | LIMITS | | | UNIT |
|--------------------------------|--|---|-----------------------|-----------------------|------|------|
| | | | Temp = -40°C to +85°C | | | |
| | | | MIN | TYP ¹ | MAX | |
| V _{IH} | HIGH level Input voltage | V _{CC} = 2.3 to 2.7V | 1.7 | 1.2 | | V |
| | | V _{CC} = 2.7 to 3.6V | 2.0 | 1.5 | | |
| V _{IL} | LOW level Input voltage | V _{CC} = 2.3 to 2.7V | | 1.2 | 0.7 | V |
| | | V _{CC} = 2.7 to 3.6V | | 1.5 | 0.8 | |
| V _{OH} | HIGH level output voltage | V _{CC} = 2.3 to 3.6V; V _I = V _{IH} or V _{IL} ; I _O = -100μA | V _{CC} -0.2 | V _{CC} | | V |
| | | V _{CC} = 2.3V; V _I = V _{IH} or V _{IL} ; I _O = -6mA | V _{CC} -0.3 | V _{CC} -0.08 | | |
| | | V _{CC} = 2.3V; V _I = V _{IH} or V _{IL} ; I _O = -12mA | V _{CC} -0.6 | V _{CC} -0.26 | | |
| | | V _{CC} = 2.7V; V _I = V _{IH} or V _{IL} ; I _O = -12mA | V _{CC} -0.5 | V _{CC} -0.14 | | |
| | | V _{CC} = 3.0V; V _I = V _{IH} or V _{IL} ; I _O = -12mA | V _{CC} -0.6 | V _{CC} -0.09 | | |
| | | V _{CC} = 3.0V; V _I = V _{IH} or V _{IL} ; I _O = -24mA | V _{CC} -1.0 | V _{CC} -0.28 | | |
| V _{OL} | LOW level output voltage | V _{CC} = 2.3 to 3.6V; V _I = V _{IH} or V _{IL} ; I _O = 100μA | | GND | 0.20 | V |
| | | V _{CC} = 2.3V; V _I = V _{IH} or V _{IL} ; I _O = 6mA | | 0.07 | 0.40 | |
| | | V _{CC} = 2.3V; V _I = V _{IH} or V _{IL} ; I _O = 12mA | | 0.15 | 0.70 | |
| | | V _{CC} = 2.7V; V _I = V _{IH} or V _{IL} ; I _O = 12mA | | 0.14 | 0.40 | |
| | | V _{CC} = 3.0V; V _I = V _{IH} or V _{IL} ; I _O = 24mA | | 0.27 | 0.55 | |
| I _I | Input leakage current | V _{CC} = 2.3 to 3.6V; V _I = V _{CC} or GND | | 0.1 | 5 | μA |
| I _{OZ} | 3-State output OFF-state current | V _{CC} = 2.3 to 3.6V; V _I = V _{IH} or V _{IL} ; V _O = V _{CC} or GND | | 0.1 | 10 | μA |
| I _{CC} | Quiescent supply current | V _{CC} = 2.3 to 3.6V; V _I = V _{CC} or GND; I _O = 0 | | 0.2 | 40 | μA |
| ΔI _{CC} | Additional quiescent supply current given per data I/O pin with bus hold | V _{CC} = 2.3V to 3.6V; V _I = V _{CC} - 0.6V; I _O = 0 | | 150 | 750 | μA |
| I _{BHL} ² | Bus hold LOW sustaining current | V _{CC} = 2.3V; V _I = 0.7V | 45 | - | | μA |
| | | V _{CC} = 3.0V; V _I = 0.8V | 75 | 150 | | |
| I _{BHH} ² | Bus hold HIGH sustaining current | V _{CC} = 2.3V; V _I = 1.7V | -45 | | | μA |
| | | V _{CC} = 3.0V; V _I = 2.0V | -75 | -175 | | |
| I _{BHLO} ² | Bus hold LOW overdrive current | V _{CC} = 3.6V | 500 | | | μA |
| I _{BHHO} ² | Bus hold HIGH overdrive current | V _{CC} = 3.6V | -500 | | | μA |

NOTES:

1. All typical values are at T_{amb} = 25°C.
2. Valid for data inputs of bus hold parts.

AC CHARACTERISTICS FOR V_{CC} = 2.3V TO 2.7V RANGEGND = 0V; t_r = t_f ≤ 2.0ns; C_L = 30pF

| SYMBOL | PARAMETER | WAVEFORM | LIMITS | | | UNIT |
|------------------------------------|---|----------|-------------------------------|------------------|-----|------|
| | | | V _{CC} = 2.3 to 2.7V | | | |
| | | | MIN | TYP ¹ | MAX | |
| t _{PHL} /t _{PLH} | Propagation delay nAn to nBn; nBn to nAn | 1, 3 | 1.0 | 2.0 | 3.7 | ns |
| t _{PZH} /t _{PZL} | 3-State output enable time nOE to nAn; nOE to nBn | 2, 3 | 1.0 | 2.7 | 5.7 | ns |
| t _{PHZ} /t _{PLZ} | 3-State output disable time nOE to nAn; nOE to nBn | 2, 3 | 1.0 | 2.2 | 5.2 | ns |

NOTES:

1. All typical values are measured at T_{amb} = 25°C and V_{CC} = 2.5V.

16-bit bus transceiver with direction pin (3-State)

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AC CHARACTERISTICS FOR $V_{CC} = 3.0V$ TO $3.6V$ RANGE AND $V_{CC} = 2.7V$

$GND = 0V$; $t_r = t_f \leq 2.5ns$; $C_L = 50pF$

| SYMBOL | PARAMETER | WAVEFORM | LIMITS | | | | | | UNIT |
|-------------------|---|----------|-------------------------|---------------------|-----|-----------------|------------------|-----|------|
| | | | $V_{CC} = 3.3 \pm 0.3V$ | | | $V_{CC} = 2.7V$ | | | |
| | | | MIN | TYP ^{1, 2} | MAX | MIN | TYP ¹ | MAX | |
| t_{PHL}/t_{PLH} | Propagation delay nAn to nBn; nBn to nAn | 1, 3 | 1.0 | 1.9 | 3.0 | 1.0 | 2.1 | 3.6 | ns |
| t_{PZH}/t_{PZL} | 3-State output enable time nOE to nAn; nOE to nBn | 2, 3 | 1.0 | 2.3 | 4.4 | 1.0 | 3.0 | 5.4 | ns |
| t_{PHZ}/t_{PLZ} | 3-State output disable time nOE to nAn; nOE to nBn | 2, 3 | 1.0 | 2.8 | 4.1 | 1.0 | 3.1 | 4.6 | ns |

NOTES:

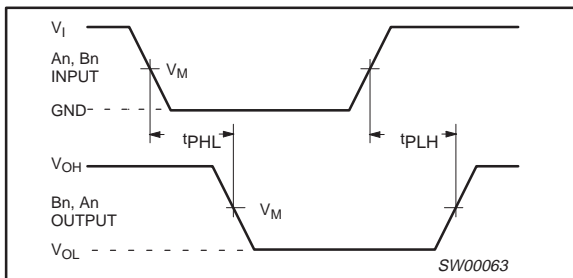
- All typical values are measured at $T_{amb} = 25^\circ C$.
- Typical value is measured at $V_{CC} = 3.3V$

AC WAVEFORMS FOR $V_{CC} = 2.3V$ TO $2.7V$ AND $V_{CC} < 2.3V$ RANGE

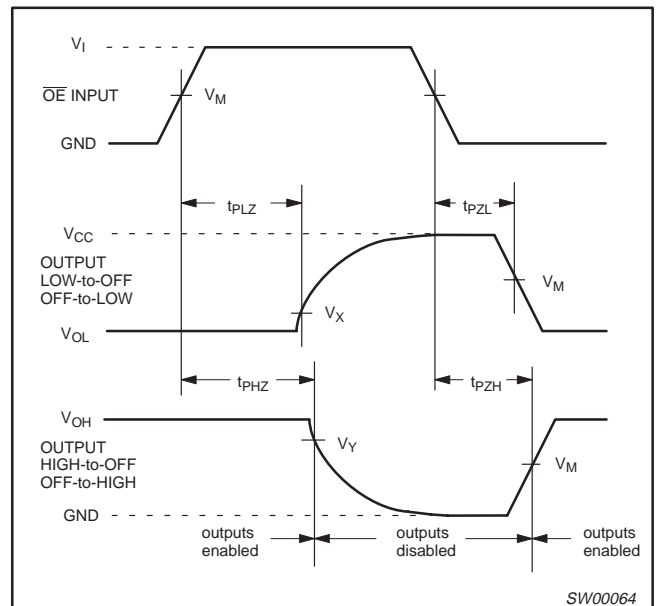
$V_M = 0.5 V_{CC}$
 $V_X = V_{OL} + 0.15V$
 $V_Y = V_{OH} - 0.15V$
 V_{OL} and V_{OH} are the typical output voltage drop that occur with the output load.
 $V_I = V_{CC}$

AC WAVEFORMS FOR $V_{CC} = 3.0V$ TO $3.6V$ AND $V_{CC} = 2.7V$ RANGE

$V_M = 1.5 V$
 $V_X = V_{OL} + 0.3V$
 $V_Y = V_{OH} - 0.3V$
 V_{OL} and V_{OH} are the typical output voltage drop that occur with the output load.
 $V_I = 2.7V$



Waveform 1. Input (nAn, nBn) to output (nBn, nAn) propagation delay times

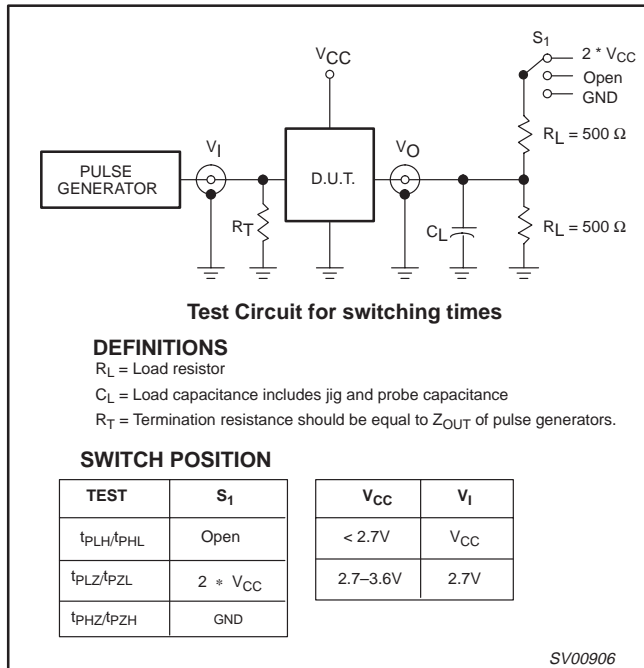


Waveform 2. 3-State enable and disable times

16-bit bus transceiver with direction pin (3-State)

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TEST CIRCUIT



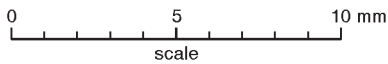
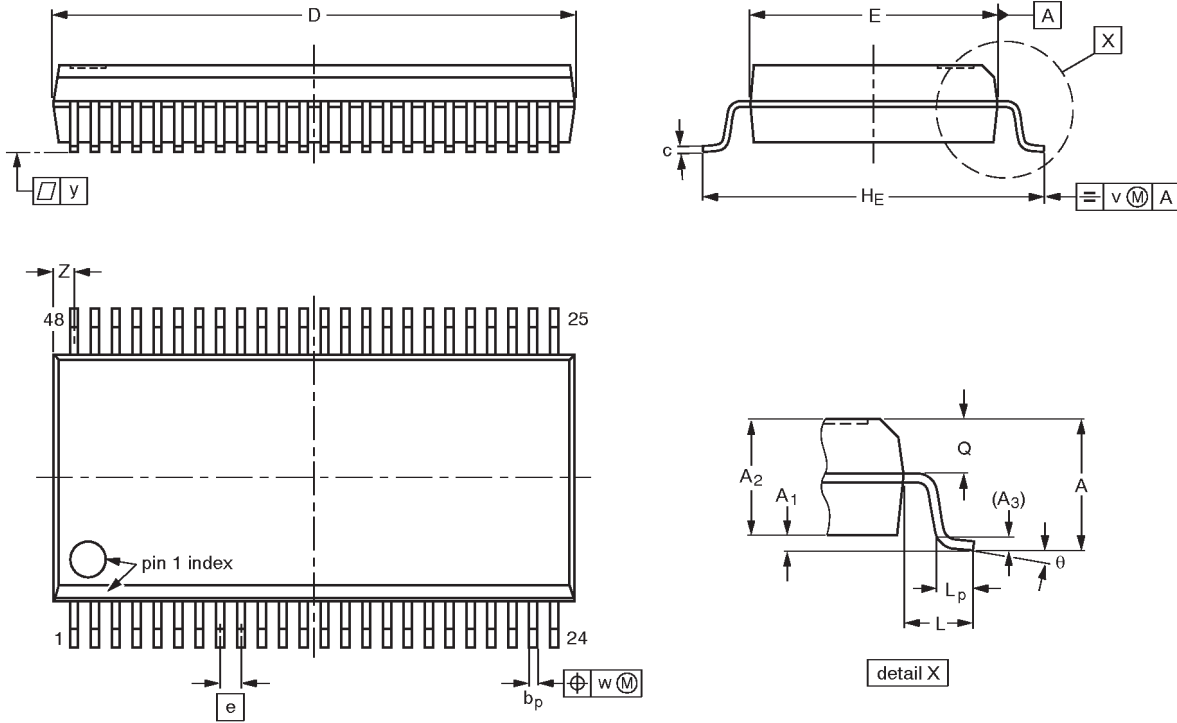
Waveform 3. Load circuitry for switching times

2.5V/3.3V 16-bit bus transceiver with direction pin
(3-State)

74ALVC16245/
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SSOP48: plastic shrink small outline package; 48 leads; body width 7.5 mm

SOT370-1



DIMENSIONS (mm are the original dimensions)

| UNIT | A max. | A ₁ | A ₂ | A ₃ | b _p | c | D ⁽¹⁾ | E ⁽¹⁾ | e | H _E | L | L _p | Q | v | w | y | Z ⁽¹⁾ | θ |
|------|--------|----------------|----------------|----------------|----------------|--------------|------------------|------------------|-------|----------------|-----|----------------|------------|------|------|-----|------------------|----------|
| mm | 2.8 | 0.4 0.2 | 2.35 2.20 | 0.25 | 0.3 0.2 | 0.22 0.13 | 16.00 15.75 | 7.6 7.4 | 0.635 | 10.4 10.1 | 1.4 | 1.0 0.6 | 1.2 1.0 | 0.25 | 0.18 | 0.1 | 0.85 0.40 | 8° 0° |

Note

1. Plastic or metal protrusions of 0.25 mm maximum per side are not included.

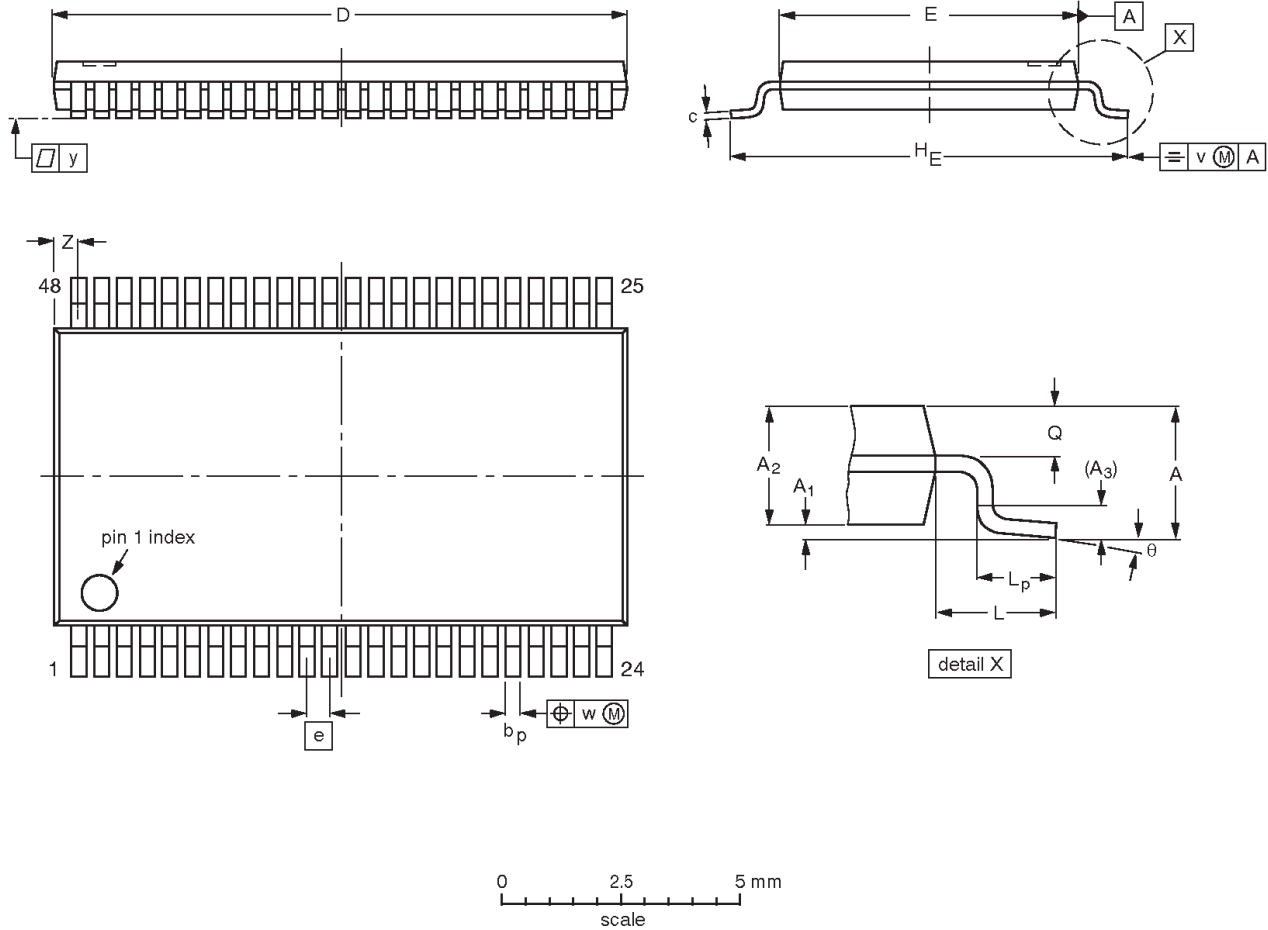
| OUTLINE VERSION | REFERENCES | | | | EUROPEAN PROJECTION | ISSUE DATE |
|-----------------|------------|----------|------|--|---------------------|-----------------------|
| | IEC | JEDEC | EIAJ | | | |
| SOT370-1 | | MO-118AA | | | | 93-11-02- 95-02-04 |

2.5V/3.3V 16-bit bus transceiver with direction pin
(3-State)

74ALVC16245/
74ALVCH16245

TSSOP48: plastic thin shrink small outline package; 48 leads; body width 6.1mm

SOT362-1



DIMENSIONS (mm are the original dimensions).

| UNIT | A max. | A ₁ | A ₂ | A ₃ | b _p | c | D ⁽¹⁾ | E ⁽²⁾ | e | H _E | L | L _p | Q | v | w | y | Z | θ |
|------|--------|----------------|----------------|----------------|----------------|------------|------------------|------------------|-----|----------------|---|----------------|--------------|------|------|-----|------------|----------|
| mm | 1.2 | 0.15 0.05 | 1.05 0.85 | 0.25 | 0.28 0.17 | 0.2 0.1 | 12.6 12.4 | 6.2 6.0 | 0.5 | 8.3 7.9 | 1 | 0.8 0.4 | 0.50 0.35 | 0.25 | 0.08 | 0.1 | 0.8 0.4 | 8° 0° |

Notes

1. Plastic or metal protrusions of 0.15 mm maximum per side are not included.
2. Plastic interlead protrusions of 0.25 mm maximum per side are not included.

| OUTLINE VERSION | REFERENCES | | | | EUROPEAN PROJECTION | ISSUE DATE |
|-----------------|------------|----------|------|--|---------------------|----------------------|
| | IEC | JEDEC | EIAJ | | | |
| SOT362-1 | | MO-153ED | | | | 93-02-03 95-02-10 |

2.5V/3.3V 16-bit bus transceiver with direction pin
(3-State)

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DEFINITIONS

| Data Sheet Identification | Product Status | Definition |
|----------------------------------|-------------------------------|--|
| <i>Objective Specification</i> | Formative or in Design | This data sheet contains the design target or goal specifications for product development. Specifications may change in any manner without notice. |
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